74AUP1G3208

Low-power 3-input OR-AND gate

Rev. 7 — 7 March 2017 **Product data sheet**

1 General description

The 74AUP1G3208 provides the Boolean function: Y = (A + B) × C. The user can choose the logic functions OR, AND and OR-AND. All inputs can be connected to V_{CC} or GND.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2 Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; I_{CC} = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

nexperia

3 Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AUP1G3208GW	-40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363
74AUP1G3208GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74AUP1G3208GF	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm	SOT891
74AUP1G3208GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115
74AUP1G3208GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202
74AUP1G3208GX	-40 °C to +125 °C	X2SON6	plastic thermal extremely thin small outline package; no leads; 6 terminals; body 1 × 0.8 × 0.35 mm	SOT1255

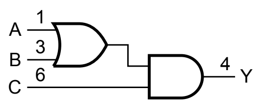
4 Marking

Table 2. Marking

Type number	Marking code [1]
74AUP1G3208GW	a2
74AUP1G3208GM	a2
74AUP1G3208GF	a2
74AUP1G3208GN	a2
74AUP1G3208GS	a2
74AUP1G3208GX	a2

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5 Functional diagram



001aad501

Figure 1. Logic symbol

6 Pinning information

6.1 Pinning

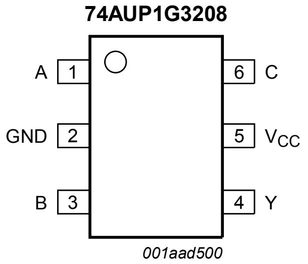


Figure 2. Pin configuration SOT363

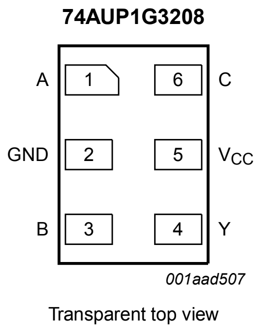


Figure 3. Pin configuration SOT886

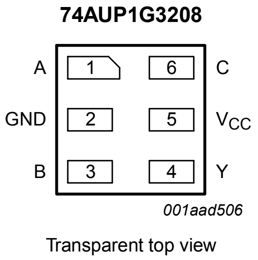


Figure 4. Pin configuration SOT891, SOT1115 and SOT1202

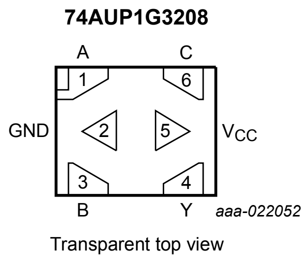


Figure 5. Pin configuration SOT1255 (X2SON6)

6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
A	1	data input A
GND	2	ground (0 V)
B	3	data input B
Y	4	data output Y
V_{CC}	5	supply voltage
C	6	data input C

7 Functional description

Table 4. Function table [1]

Input			Output
C	B	A	Y
L	L	L	L
L	L	H	L
L	H	L	L
L	H	H	L
H	L	L	L
H	L	H	H
H	H	L	H
H	H	H	H

[1] H = HIGH voltage level;
L = LOW voltage level.

7.1 Logic configurations

Table 5. Function selection table

Logic function	Figure
2-input AND	see Figure 6 and Figure 7
2-input OR	see Figure 8
3-input gate with the Boolean function: Y = (A + B) × C	see Figure 9

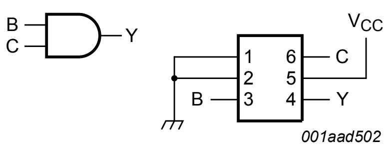


Figure 6. 2-input AND gate

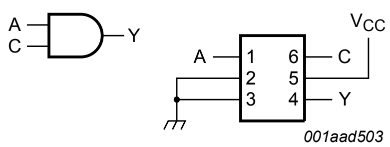


Figure 7. 2-input AND gate

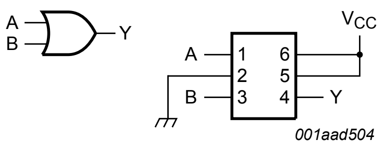


Figure 8. 2-input OR gate

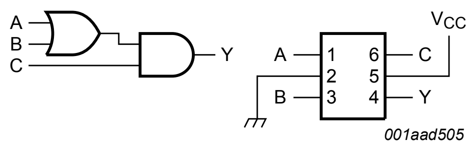


Figure 9. 3-input gate with the Boolean function: Y = (A + B) × C

8 Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
V_I	input voltage	[1]	-0.5	+4.6	V
V_O	output voltage	Active mode and Power-down mode [1]	-0.5	+4.6	V
I_{IK}	input clamping current	$V_I < 0$ V	-50	-	mA
I_{OK}	output clamping current	$V_O < 0$ V	-50	-	mA
I_O	output current	$V_O = 0$ V to V_{CC}	-	±20	mA
I_{CC}	supply current		-	50	mA
I_{GND}	ground current		-50	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C [2]	-	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SC-88 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K.
For XSON6 and X2SON6 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9 Recommended operating conditions

Table 7. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		0.8	3.6	V
V_I	input voltage		0	3.6	V
V_O	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; $V_{CC} = 0$ V	0	3.6	V
T_{amb}	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 0.8 V to 3.6 V	-	200	ns/V

10 Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V	0.70 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V	0.65 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V	-	-	0.30 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V	-	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V	-	-	0.9	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = -20 μA; V_{CC} = 0.8 V to 3.6 V	V_{CC} - 0.1	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V	0.75 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V	1.11	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V	1.32	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V	2.05	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V	1.9	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V	2.72	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V	2.6	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V	-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V	-	-	0.31	V
		I_O = 1.9 mA; V_{CC} = 1.65 V	-	-	0.31	V
		I_O = 2.3 mA; V_{CC} = 2.3 V	-	-	0.31	V
		I_O = 3.1 mA; V_{CC} = 2.3 V	-	-	0.44	V
		I_O = 2.7 mA; V_{CC} = 3.0 V	-	-	0.31	V
		I_O = 4.0 mA; V_{CC} = 3.0 V	-	-	0.44	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.1	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.2	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V	-	-	±0.2	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	0.5	μA

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
ΔI_{CC}	additional supply current	$V_I = V_{CC} - 0.6$ V; $I_O = 0$ A; $V_{CC} = 3.3$ V [1]	-	-	40	µA
C_I	input capacitance	$V_{CC} = 0$ V to 3.6 V; V_I = GND or V_{CC}	-	0.8	-	pF
C_O	output capacitance	V_O = GND; $V_{CC} = 0$ V	-	1.7	-	pF
T_{amb} = -40 °C to +85 °C						
V_{IH}	HIGH-level input voltage	$V_{CC} = 0.8$ V	0.70 × V_{CC}	-	-	V
		$V_{CC} = 0.9$ V to 1.95 V	0.65 × V_{CC}	-	-	V
		$V_{CC} = 2.3$ V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0$ V to 3.6 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 0.8$ V	-	-	0.30 × V_{CC}	V
		$V_{CC} = 0.9$ V to 1.95 V	-	-	0.35 × V_{CC}	V
		$V_{CC} = 2.3$ V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0$ V to 3.6 V	-	-	0.9	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = -20$ µA; $V_{CC} = 0.8$ V to 3.6 V	$V_{CC} - 0.1$	-	-	V
		$I_O = -1.1$ mA; $V_{CC} = 1.1$ V	0.7 × V_{CC}	-	-	V
		$I_O = -1.7$ mA; $V_{CC} = 1.4$ V	1.03	-	-	V
		$I_O = -1.9$ mA; $V_{CC} = 1.65$ V	1.30	-	-	V
		$I_O = -2.3$ mA; $V_{CC} = 2.3$ V	1.97	-	-	V
		$I_O = -3.1$ mA; $V_{CC} = 2.3$ V	1.85	-	-	V
		$I_O = -2.7$ mA; $V_{CC} = 3.0$ V	2.67	-	-	V
		$I_O = -4.0$ mA; $V_{CC} = 3.0$ V	2.55	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20$ µA; $V_{CC} = 0.8$ V to 3.6 V	-	-	0.1	V
		$I_O = 1.1$ mA; $V_{CC} = 1.1$ V	-	-	0.3 × V_{CC}	V
		$I_O = 1.7$ mA; $V_{CC} = 1.4$ V	-	-	0.37	V
		$I_O = 1.9$ mA; $V_{CC} = 1.65$ V	-	-	0.35	V
		$I_O = 2.3$ mA; $V_{CC} = 2.3$ V	-	-	0.33	V
		$I_O = 3.1$ mA; $V_{CC} = 2.3$ V	-	-	0.45	V
		$I_O = 2.7$ mA; $V_{CC} = 3.0$ V	-	-	0.33	V
		$I_O = 4.0$ mA; $V_{CC} = 3.0$ V	-	-	0.45	V
I_I	input leakage current	V_I = GND to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	µA
I_{OFF}	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.5	µA
ΔI_{OFF}	additional power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.6	µA
I_{CC}	supply current	V_I = GND or V_{CC}; $I_O = 0$ A; $V_{CC} = 0.8$ V to 3.6 V	-	-	0.9	µA

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
ΔI_{CC}	additional supply current	$V_I = V_{CC} - 0.6$ V; $I_O = 0$ A; $V_{CC} = 3.3$ V	[1]	-	-	50	μA
T_{amb} = -40 °C to +125 °C							
V_{IH}	HIGH-level input voltage	$V_{CC} = 0.8$ V		0.75 × V_{CC}	-	-	V
		$V_{CC} = 0.9$ V to 1.95 V		0.70 × V_{CC}	-	-	V
		$V_{CC} = 2.3$ V to 2.7 V		1.6	-	-	V
		$V_{CC} = 3.0$ V to 3.6 V		2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 0.8$ V		-	-	0.25 × V_{CC}	V
		$V_{CC} = 0.9$ V to 1.95 V		-	-	0.30 × V_{CC}	V
		$V_{CC} = 2.3$ V to 2.7 V		-	-	0.7	V
		$V_{CC} = 3.0$ V to 3.6 V		-	-	0.9	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		$I_O = -20$ μA; $V_{CC} = 0.8$ V to 3.6 V		$V_{CC} - 0.11$	-	-	V
		$I_O = -1.1$ mA; $V_{CC} = 1.1$ V		0.6 × V_{CC}	-	-	V
		$I_O = -1.7$ mA; $V_{CC} = 1.4$ V		0.93	-	-	V
		$I_O = -1.9$ mA; $V_{CC} = 1.65$ V		1.17	-	-	V
		$I_O = -2.3$ mA; $V_{CC} = 2.3$ V		1.77	-	-	V
		$I_O = -3.1$ mA; $V_{CC} = 2.3$ V		1.67	-	-	V
		$I_O = -2.7$ mA; $V_{CC} = 3.0$ V		2.40	-	-	V
		$I_O = -4.0$ mA; $V_{CC} = 3.0$ V		2.30	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		$I_O = 20$ μA; $V_{CC} = 0.8$ V to 3.6 V		-	-	0.11	V
		$I_O = 1.1$ mA; $V_{CC} = 1.1$ V		-	-	0.33 × V_{CC}	V
		$I_O = 1.7$ mA; $V_{CC} = 1.4$ V		-	-	0.41	V
		$I_O = 1.9$ mA; $V_{CC} = 1.65$ V		-	-	0.39	V
		$I_O = 2.3$ mA; $V_{CC} = 2.3$ V		-	-	0.36	V
		$I_O = 3.1$ mA; $V_{CC} = 2.3$ V		-	-	0.50	V
		$I_O = 2.7$ mA; $V_{CC} = 3.0$ V		-	-	0.36	V
		$I_O = 4.0$ mA; $V_{CC} = 3.0$ V		-	-	0.50	V
I_I	input leakage current	V_I = GND to 3.6 V; $V_{CC} = 0$ V to 3.6 V		-	-	±0.75	μA
I_{OFF}	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V		-	-	±0.75	μA
ΔI_{OFF}	additional power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V		-	-	±0.75	μA
I_{CC}	supply current	V_I = GND or V_{CC}; $I_O = 0$ A; $V_{CC} = 0.8$ V to 3.6 V		-	-	1.4	μA
ΔI_{CC}	additional supply current	$V_I = V_{CC} - 0.6$ V; $I_O = 0$ A; $V_{CC} = 3.3$ V	[1]	-	-	75	μA

[1] One input at $V_{CC} - 0.6$ V, other inputs at V_{CC} or GND.

11 Dynamic characteristics

Table 9. Dynamic characteristics

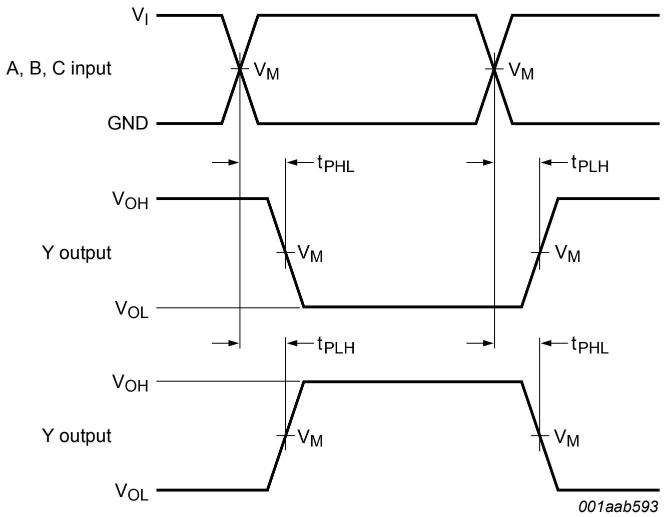
Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 11.

Symbol	Parameter	Conditions	25 °C			-40 °C to +125 °C			Unit
			Min	Typ [1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 5 pF									
t_{pd}	propagation delay	A, B or C to Y; see Figure 10 [2]							
		V_{CC} = 0.8 V	-	18.5	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.2	5.4	10.6	2.2	10.9	11.1	ns
		V_{CC} = 1.4 V to 1.6 V	1.9	3.8	6.4	1.8	6.9	7.2	ns
		V_{CC} = 1.65 V to 1.95 V	1.5	3.1	5.1	1.4	5.6	5.9	ns
		V_{CC} = 2.3 V to 2.7 V	1.3	2.4	3.7	1.2	4.1	4.4	ns
		V_{CC} = 3.0 V to 3.6 V	1.2	2.2	3.2	1.1	3.4	3.6	ns
C_L = 10 pF									
t_{pd}	propagation delay	A, B or C to Y; see Figure 10 [2]							
		V_{CC} = 0.8 V	-	22.1	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.6	6.3	12.4	2.5	12.8	13.1	ns
		V_{CC} = 1.4 V to 1.6 V	2.3	4.4	7.4	2.1	8.0	8.4	ns
		V_{CC} = 1.65 V to 1.95 V	2.0	3.6	5.9	1.8	6.4	6.8	ns
		V_{CC} = 2.3 V to 2.7 V	1.7	3.0	4.4	1.6	4.8	5.1	ns
		V_{CC} = 3.0 V to 3.6 V	1.6	2.7	3.9	1.4	4.2	4.4	ns
C_L = 15 pF									
t_{pd}	propagation delay	A, B or C to Y; see Figure 10 [2]							
		V_{CC} = 0.8 V	-	25.6	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.0	7.1	14.1	2.8	14.6	14.9	ns
		V_{CC} = 1.4 V to 1.6 V	2.6	5.0	8.4	2.4	9.1	9.5	ns
		V_{CC} = 1.65 V to 1.95 V	2.2	4.1	6.7	2.1	7.4	7.8	ns
		V_{CC} = 2.3 V to 2.7 V	2.0	3.4	5.0	1.9	5.5	5.9	ns
		V_{CC} = 3.0 V to 3.6 V	1.9	3.2	4.5	1.7	4.8	5.0	ns
C_L = 30 pF									
t_{pd}	propagation delay	A, B or C to Y; see Figure 10 [2]							
		V_{CC} = 0.8 V	-	34.1	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.9	9.3	18.9	3.7	19.7	20.1	ns
		V_{CC} = 1.4 V to 1.6 V	3.4	6.5	11.0	3.2	12.1	12.7	ns
		V_{CC} = 1.65 V to 1.95 V	3.0	5.4	8.9	2.9	9.7	10.3	ns
		V_{CC} = 2.3 V to 2.7 V	2.8	4.5	6.5	2.6	7.1	7.5	ns
		V_{CC} = 3.0 V to 3.6 V	2.6	4.3	5.8	2.4	6.4	6.7	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +125 °C			Unit
			Min	Typ [1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 5 pF, 10 pF, 15 pF and 30 pF									
C_{PD}	power dissipation capacitance	f_i = 1 MHz; V_I = GND to V_{CC} [3]							
		V_{CC} = 0.8 V	-	2.6	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V	-	2.7	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V	-	2.8	-	-	-	-	pF
		V_{CC} = 1.65 V to 1.95 V	-	3.0	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	3.5	-	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V	-	4.0	-	-	-	-	pF

[1] All typical values are measured at nominal V_{CC}.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}.
[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

11.1 Waveforms and test circuit



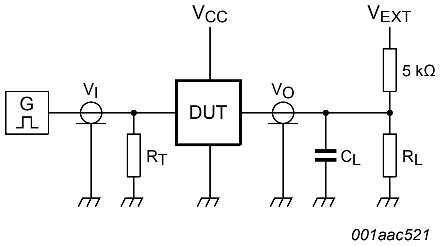
Measurement points are given in Table 10.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 10. Input A, B and C to output Y propagation delay times

Table 10. Measurement points

Supply voltage	Output	Input		
V_{CC}	V_M	V_M	V_I	$t_r = t_f$
0.8 V to 3.6 V	0.5 × V_{CC}	0.5 × V_{CC}	V_{CC}	≤ 3.0 ns



Test data is given in Table 11.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to the output impedance Z_O of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Figure 11. Test circuit for measuring switching times

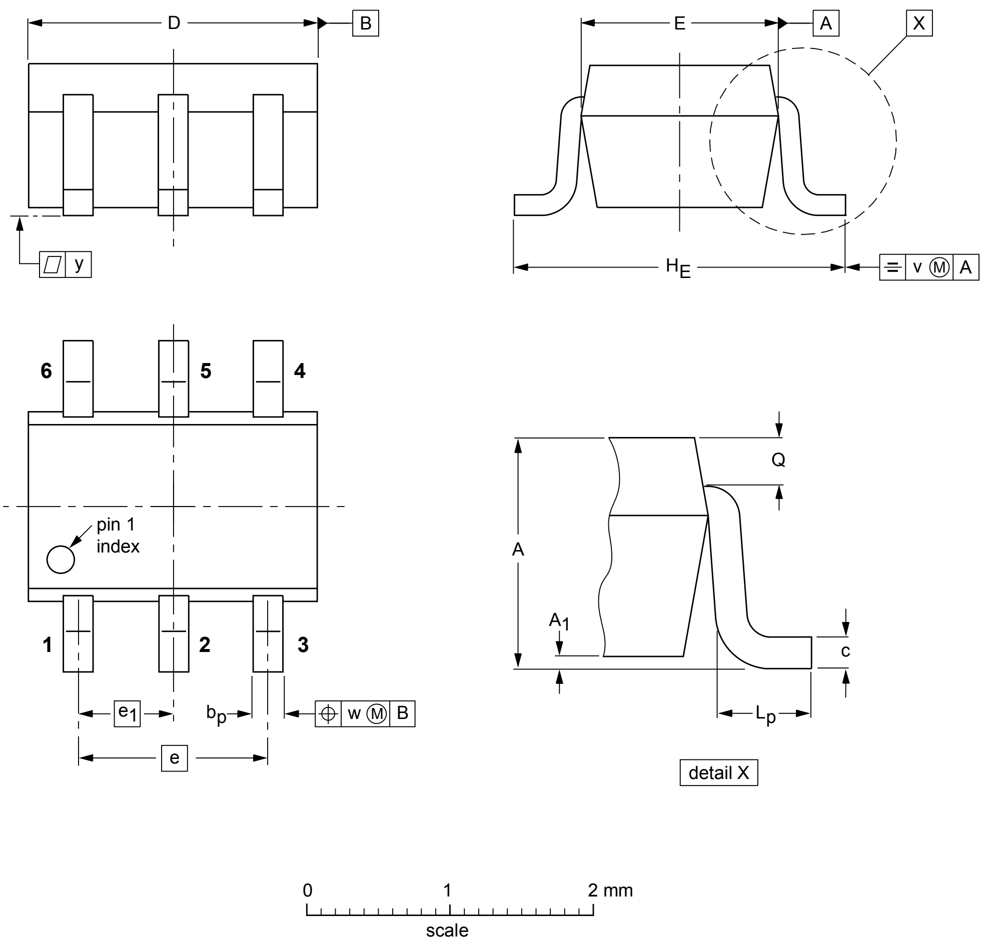
Table 11. Test data

Supply voltage	Load		V_{EXT}		
V_{CC}	C_L	R_L [1]	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	2 × V_{CC}

[1] For measuring enable and disable times R_L = 5 kΩ.
For measuring propagation delays, setup and hold times and pulse width R_L = 1 MΩ.

12 Package outline

Plastic surface-mounted package; 6 leads **SOT363**



DIMENSIONS (mm are the original dimensions)

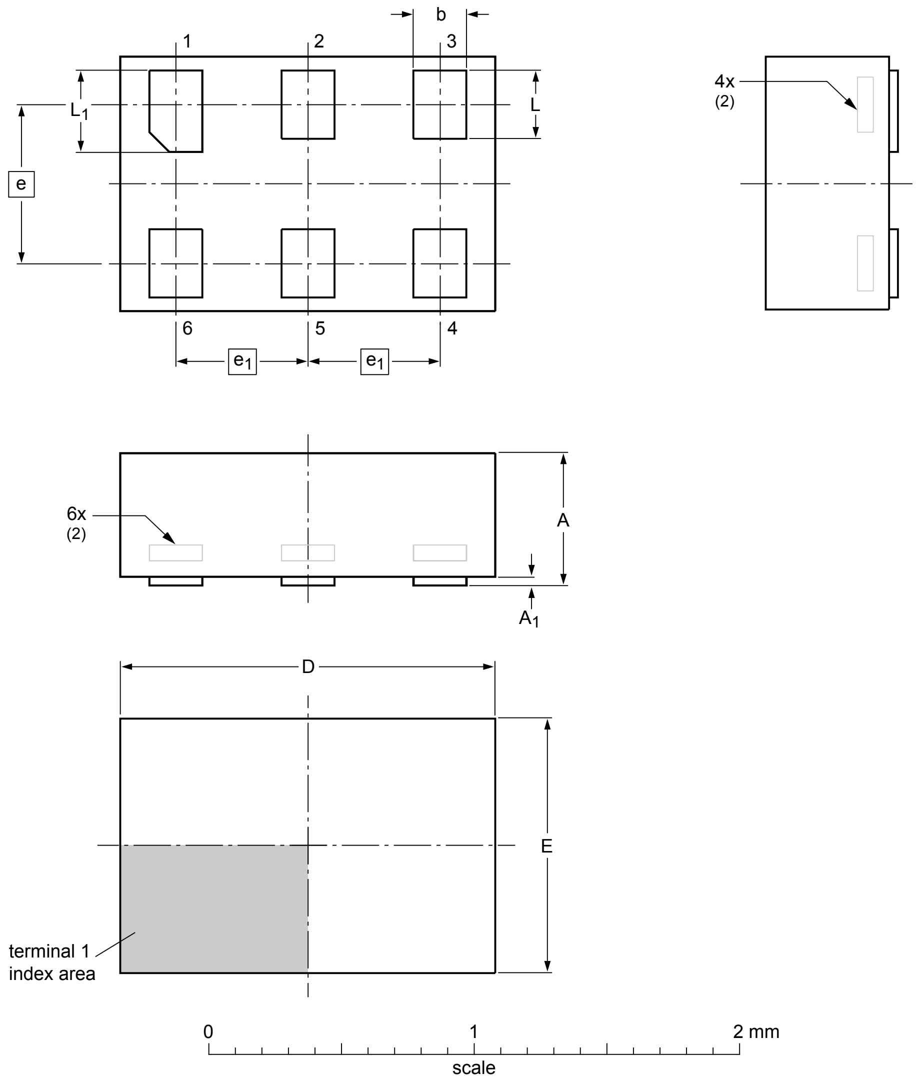
UNIT	A	A_1 max	b_p	c	D	E	e	e_1	H_E	L_p	Q	v	w	y
mm	1.1 0.8	0.1	0.30 0.20	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.25 0.15	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT363			SC-88			~~04-11-08~~ 06-03-16

Figure 12. Package outline SOT363 (SC-88)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886



Dimensions (mm are the original dimensions)

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.5	0.04	0.25	1.50	1.05			0.35	0.40
	nom			0.20	1.45	1.00	0.6	0.5	0.30	0.35
	min			0.17	1.40	0.95			0.27	0.32

Notes

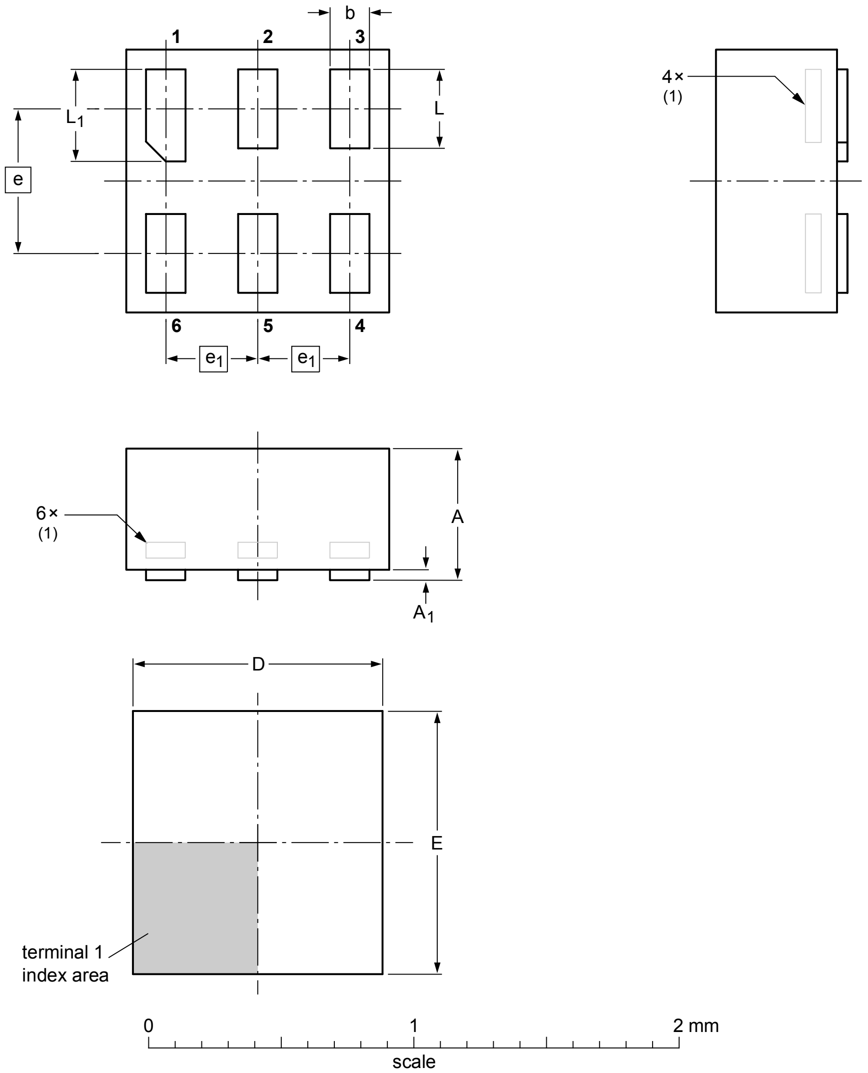
1. Including plating thickness.
2. Can be visible in some manufacturing processes.

sot886_po

Outline version	References: IEC	References: JEDEC	References: JEITA		European projection	Issue date
SOT886		MO-252				~~04-07-22~~ 12-01-05

Figure 13. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm **SOT891**



DIMENSIONS (mm are the original dimensions)

UNIT	A max	A_1 max	b	D	E	e	e_1	L	L_1
mm	0.5	0.04	0.20 0.12	1.05 0.95	1.05 0.95	0.55	0.35	0.35 0.27	0.40 0.32

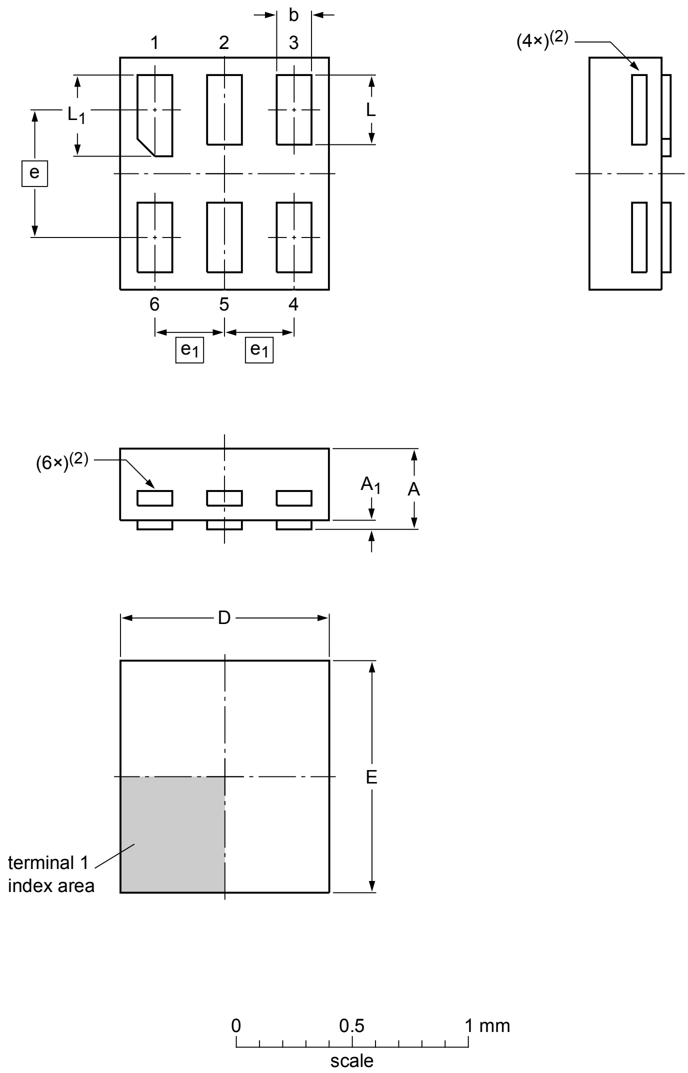
Note

1. Can be visible in some manufacturing processes.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT891						~~05-04-06~~ 07-05-15

Figure 14. Package outline SOT891 (XSON6)

XSON6: extremely thin small outline package; no leads;
6 terminals; body 0.9 x 1.0 x 0.35 mm **SOT1115**



Dimensions

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	0.95	1.05			0.35	0.40
	nom			0.15	0.90	1.00	0.55	0.3	0.30	0.35
	min			0.12	0.85	0.95			0.27	0.32

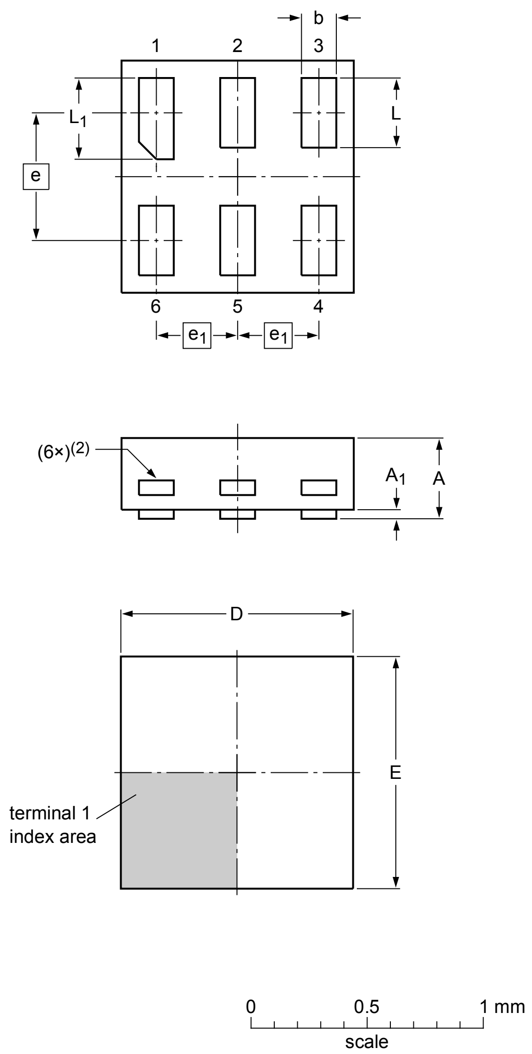
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1115_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1115						~~10-04-02~~ 10-04-07

Figure 15. Package outline SOT1115 (XSON6)

**XSON6: extremely thin small outline package; no leads;
6 terminals; body 1.0 x 1.0 x 0.35 mm** **SOT1202**



Dimensions

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
	max	0.35	0.04	0.20	1.05	1.05			0.35	0.40
mm	nom			0.15	1.00	1.00	0.55	0.35	0.30	0.35
	min			0.12	0.95	0.95			0.27	0.32

Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1202_po

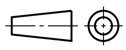
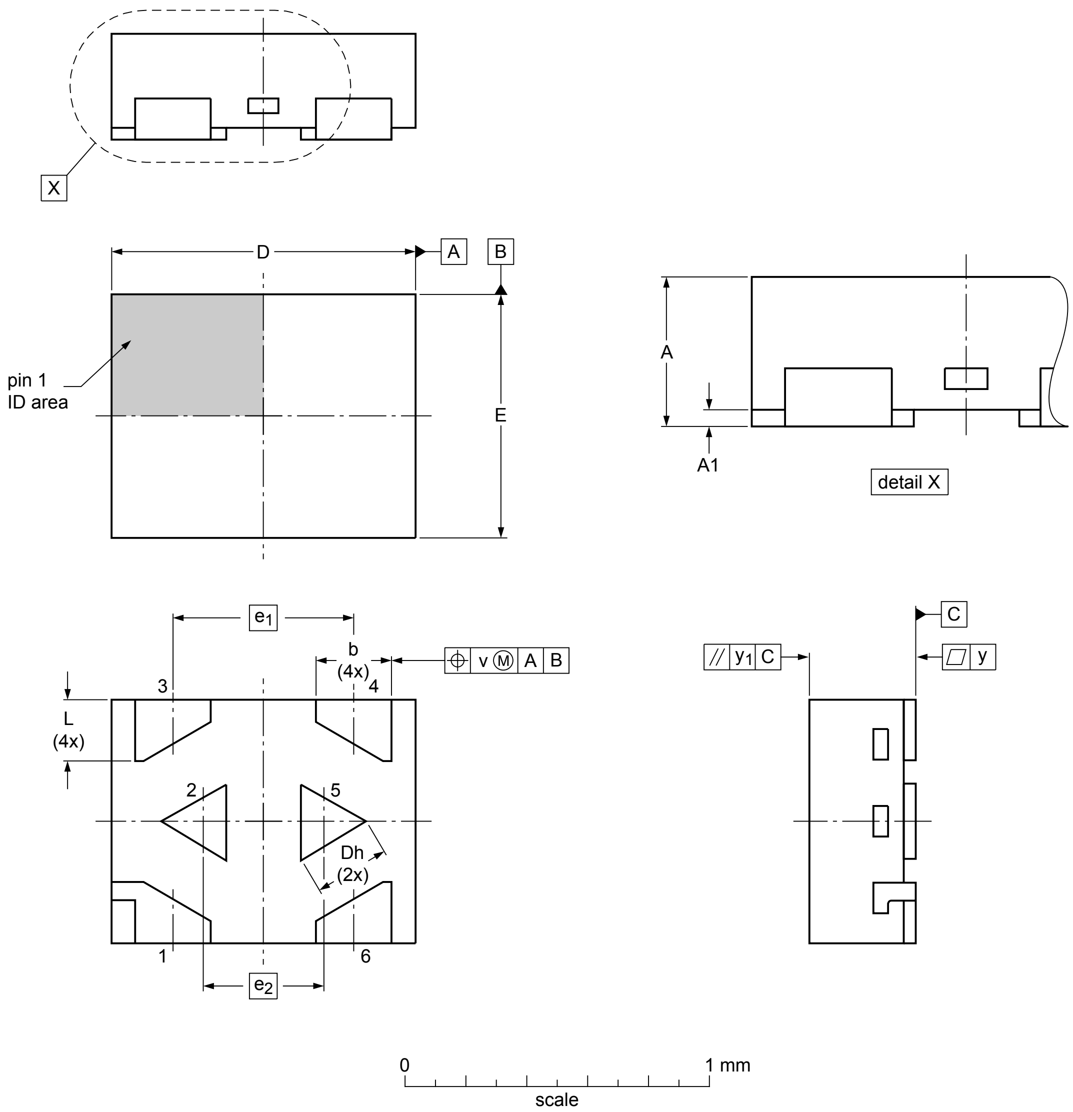
Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1202						~~10-04-02~~ 10-04-06

Figure 16. Package outline SOT1202 (XSON6)

X2SON6: plastic thermal enhanced extremely thin small outline package; no leads; 6 terminals; body 1.0 x 0.8 x 0.35 mm **SOT1255**



Dimensions (mm are the original dimensions)

Unit		A	A_1	D	D_h	E	e_1	e_2	b	L	v	y	y_1
	max	0.35	0.04	1.05	0.30	0.85			0.30	0.25			
mm	nom	0.32	0.02	1.00	0.25	0.80	0.60	0.40	0.25	0.20	0.10	0.05	0.05
	min	0.30	0.00	0.95	0.22	0.75			0.22	0.17			

sot1255_po

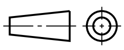
Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1255						~~15-07-20~~ 15-07-22

Figure 17. Package outline SOT1255 (X2SON6)

13 Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

14 Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G3208 v.7	20170307	Product data sheet	-	74AUP1G3208 v.6
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate.			
74AUP1G3208 v.6	20160309	Product data sheet	-	74AUP1G3208 v.5
Modifications:	• Added type number 74AUP1G3208GX (SOT1255/X2SON6)			
74AUP1G3208 v.5	20120622	Product data sheet	-	74AUP1G3208 v.4
Modifications:	• Package outline drawing of SOT886 (Figure 13) modified.			
74AUP1G3208 v.4	20111123	Product data sheet	-	74AUP1G3208 v.3
Modifications:	• Legal pages updated.			
74AUP1G3208 v.3	20101011	Product data sheet	-	74AUP1G3208 v.2
74AUP1G3208 v.2	20090703	Product data sheet	-	74AUP1G3208 v.1
74AUP1G3208 v.1	20061129	Product data sheet	-	-

15 Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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Contents

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